

## 3A, 100V - 200V Ultra Fast Surface Mount Rectifier

### FEATURES

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

### MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.200g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	3	A
$V_{RRM}$	100 - 200	V
$I_{FSM}$	85	A
$T_{J\ MAX}$	175	°C
Package	DO-214AB (SMC)	
Configuration	Single die	


**HALOGEN  
FREE**

**DO-214AB (SMC)**


ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PU3BCH	PU3DCH	UNIT
Marking code on the device			PU3BC	PU3DC	
Repetitive peak reverse voltage		V <sub>RRM</sub>	100	200	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	70	140	V
Forward current		I <sub>F</sub>	3		A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I <sub>FSM</sub>	85		A
	t = 1.0ms		180		
Junction temperature		T <sub>J</sub>	-55 to +175		°C
Storage temperature		T <sub>STG</sub>	-55 to +175		°C

**THERMAL PERFORMANCE**

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	14	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	58	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	16	°C/W

**Thermal Performance Note:** Units mounted on PCB (16mm x 16mm Cu pad test board)

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 1.5\text{A}, T_J = 25^\circ\text{C}$	$V_F$	0.81	-	V
	$I_F = 3.0\text{A}, T_J = 25^\circ\text{C}$		0.86	0.93	V
	$I_F = 1.5\text{A}, T_J = 125^\circ\text{C}$		0.66	-	V
	$I_F = 3.0\text{A}, T_J = 125^\circ\text{C}$		0.73	-	V
Reverse current @ rated $V_R$ <sup>(2)</sup>	$T_J = 25^\circ\text{C}$	$I_R$	-	2	$\mu\text{A}$
	$T_J = 125^\circ\text{C}$		-	10	$\mu\text{A}$
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	$C_J$	47	-	pF
Reverse recovery time	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	$t_{rr}$	-	25	ns
	$I_F = 1.0\text{A}, di/dt = 50\text{A}/\mu\text{s}, V_R = 30\text{V}$		31	-	
Reverse recovery current	$I_F = 3.0\text{A}, di/dt = 200\text{A}/\mu\text{s}, V_R = 100\text{V}$	$I_{RM}$	4.9	-	A
Reverse recovery charge		$Q_{rr}$	51	-	nC
Reverse recovery time		$t_{rr}$	23	-	ns

**Notes:**

1. Pulse test with  $PW = 0.3\text{ms}$
2. Pulse test with  $PW = 30\text{ms}$

**ORDERING INFORMATION**

ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
PU3xCH	DO-214AB (SMC)	3,000/ Tape & Reel

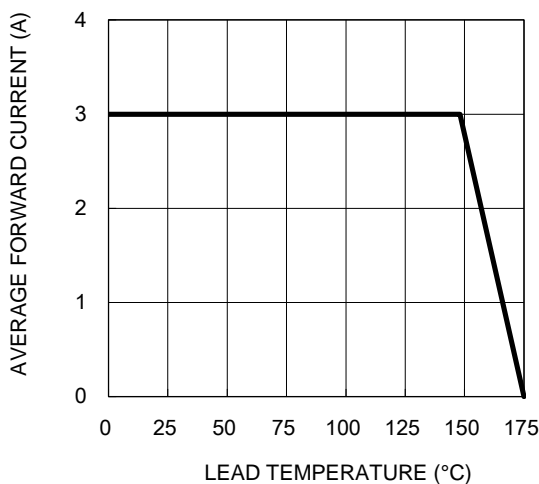
**Notes:**

1. "x" defines voltage from 100V(PU3BCH) to 200V(PU3DCH)

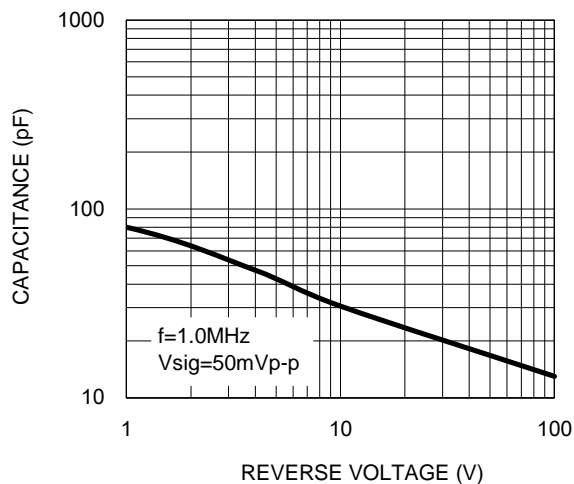
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

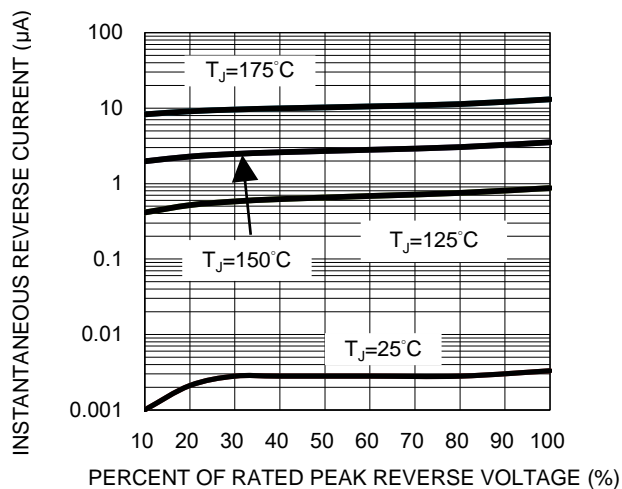
**Fig.1 Forward Current Derating Curve**



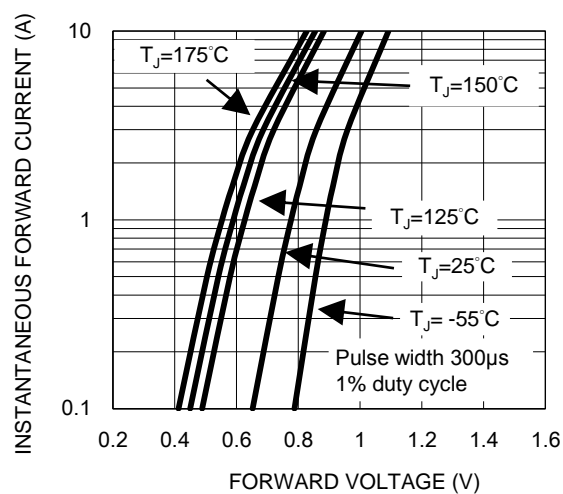
**Fig.2 Typical Junction Capacitance**



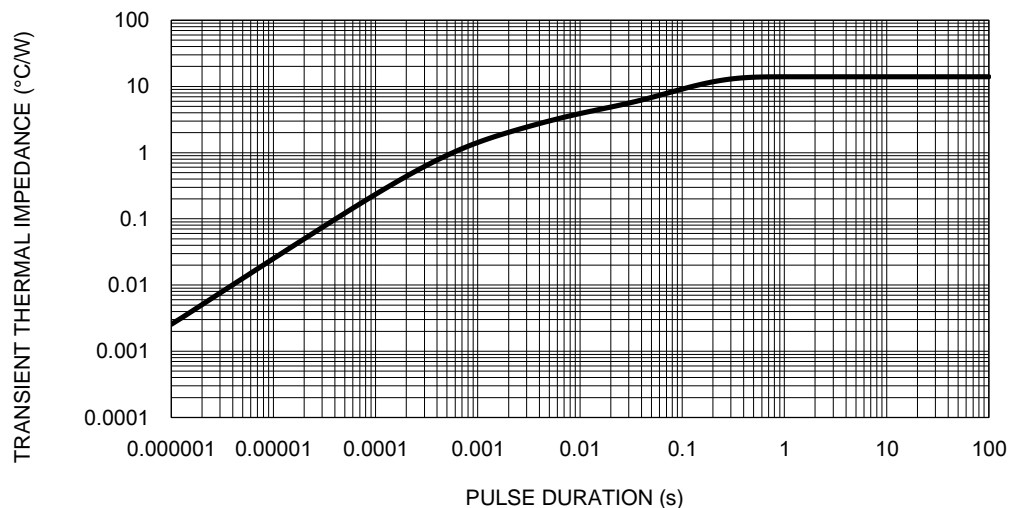
**Fig.3 Typical Reverse Characteristics**



**Fig.4 Typical Forward Characteristics**

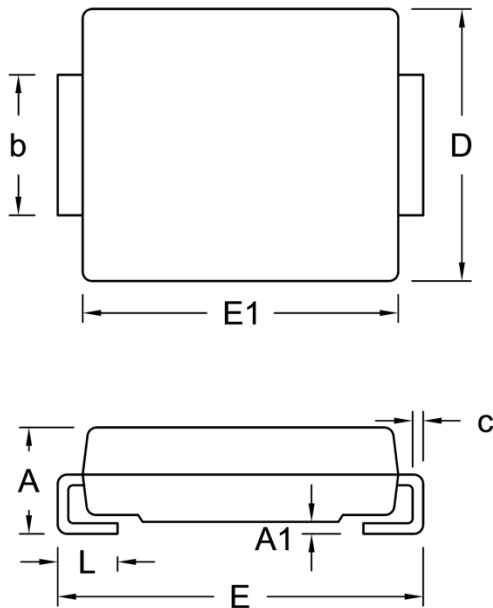


**Fig.5 Typical Transient Thermal Impedance**



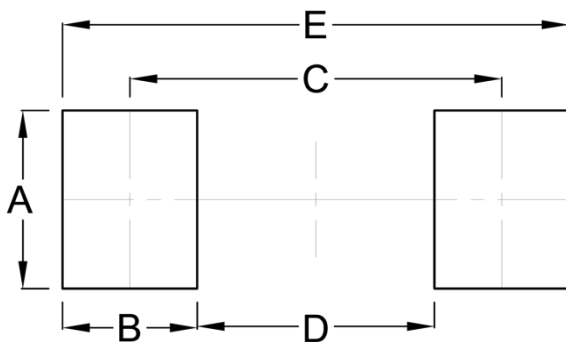
## PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.90	0.272
D	4.40	0.173
E	9.40	0.370

## MARKING DIAGRAM



P/N = Marking Code  
G = Green Compound  
YW = Date Code  
F = Factory Code

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